TACT Switch[™] High Operation Force with 5mm Height (Surface Mount Type)

SKPG Series

RoHS

Low-profile Surface mount type with high operation force most suitable for in-car components.

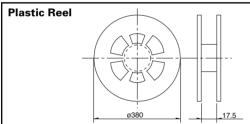


Product Line

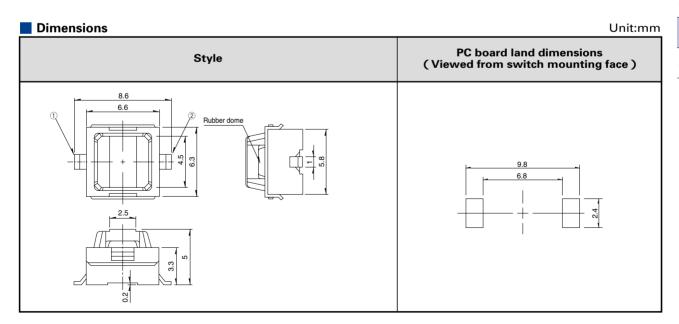
Product No.	Operating force	Operating direction				Operating life (5mA 5V DC)	Initial contact resistance	Rubber color	Minimum order unit (pcs.)	Dua Pac
SKPGACE010	1.18N							Light blue		TAC
SKPGAAE010	2.45N	Vertical	1.3	5mA 12V DC	10 µ A 1V DC	50,000cycles	1k max.	Green	1,200	
SKPGABE010	2.94N			121 00	TVDC			Blue		Cu

Specification of Embossed Taping Package (Taping Packaging for Auto-insertion) Unit:mm

Reel Size



Num	-		
1 reel	1 case /Japan	1 case /export packing	Tape width (mm)
1,200	9,600	9,600	16



Circuit Diagram

Note

1. For 330mm diameter reel requirements, please contact us. 2. Please place purchase orders for taping products per minimum order unit (1 reel or a case).

Detector

Push

Slide

Power

l-in-line kage Type

Switch™

stom-**Products**

Feeling Snap-in Туре Surface

Sharp Feeling Soft



www.DataSheet4U.com

List of Varieties

Soft Feeling Type

	Series		SKEG	SKPE	SKEG	SKEY	SKPF	SKPM	SKPN	SKPG	SKPL	SKPD
	Photo				\$		R.					
	Туре		,		Snap–in			Surface mount			Radial	
F	eature	e	Horizontal				High operation force Low contact			Round terminal and		
					type		and long stroke	resis	tance		low contact resistance	
Operating direction	Vert	tical										
ting	Horiz	ontal		1			,		1	1		
		w	6	6.6	7.5	7.8	8	5.9	6	6.6	46.45	7.8
	nsions m)	D	0	6.3	9.9	7.0	9	6	6.7	6.3	¢6.45	7.0
		н	7	5	7.3	5	10	5	7		5	
Contact					Carbon			Sil	ver	Carbon	Silver	Carbon
fo	ation rce rage	1N	1	Î Î	1	Ţ	Ţ	Ĵ	\$	↓ ↓	\$	Ţ
	-	5N										
Grou	nd terr	ninal										
Operating temperature			-20 to +70 SKEG									
	range	-					-40 to	+ 90				
Elec		ation tance	100M min. 100V DC SKEY/PD : 50M min. 100V DC									
Electrical		Voltage proof 250V AC for 1min. SKPN : 200V AC for 1min. SKEY/PD : 100V AC for 1min.										
	Vibra			10		Hz/min., th	ne amplitud	le is 1.5m	m for all th		cies,	
Durability	Lifet	time					n of X, Y an ordance witl					
<	Co	old	-30 ± 2 for 96h									
5			80 ± 2 for 96h									
Environ		heat										
Environmental	Dry	heat o heat				60 +	2 90 to 9	95%BH for	r 96h			

D epth. The most outer dimension excluding terminal portion.
H : Height. The minimum dimension if there are variances.



260°C max. 3 sec max.

Time

230°C

40s max.

Soldering Conditions

Condition for Reflow

Available for Surface Mount Type.

1. Heating method: Double heating method with infrared heater.

Temperature (°C)

180

150

2. Temperature measurement: Thermocouple 0.1 to 0.2 CA(K) or CC(T) at solder joints (copper foil surface). A heat resistive tape should be used to fix thermocouple.

Push 3. Temperature profile

Slide

Detector

Rotarv

Encoders

Power

Dual-in-line Package Type

TACT Switch[™]

Custom-Products

Note

1. The above temperature shall be measured on the mounting surface of a PC board. There are cases where the PC board's temperature greatly differs from that of the switch, depending on the material, size, thickness of PC boards and others. The above-stated conditions shall also apply to switch surface temperatures.

3 to 4min.

Time inside soldering equipment

120 sec max. (pre-heating

2. Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.

Sharp Feeling Soft Feeling Snap-in Type Surface Mount Type Radial Type

Conditions for Auto-dip Available for Snap-in Type and Radial Type (Except SKHJ, SKHL, SKQJ, SKQK, SKEG series)

Items	Condition				
Flux built-up	Mounting surface should not be exposed to fluk				
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100 max.				
Preheating time	60s max.				
Soldering temperature	260 max.				
Duration of immersion	5s max.				
Number of soldering	2times max.				

Manual Soldering (Except SKRT Series)

ltems	Condition				
Soldering temperature	350 max.				
Duration of soldering	3s max.				
Capacity of soldering iron	60W max.				

Notes

- 1. Consult with us for availability of TACT Switch[™] washing.
- 2. Prevent flux penetration from the top side of the TACT Switch[™].
- 3. Switch terminals and a PC board should not be coated with flux prior to soldering.
- 4. The second soldering should be done after the switch is stable with normal temperature.
- 5. Use the flux with a specific gravity of min 0.81.
- (EC-19S-8 by TAMURA Corporation, or equivalents.)

ALPS